

Product Summary

V _{RRM} (V)	I _F (A)	V _F Max (V) @ I _F = 4A	I _R Max (μA)
50/100/200/ 400/600/800/ 1000	8.0	1.0	5.0

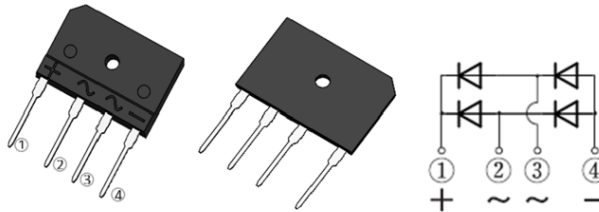
Mechanical Data

- Package: GBJ
- Package Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Terminals: Plated Leads, Lead-Free Plating (Tin Finish). Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: Molded on Body
- Mounting: Through Hole for #6 Screw
- Mounting Torque: 5.0 in-lbs Maximum
- Marking: Type Number
- Weight: 6.6 grams (Approximate)

Features

- Glass Passivated Die Construction
- High Case Dielectric Strength of 1500V_{RMS}
- Low Reverse Leakage Current
- Surge Overload Rating to 170A Peak
- Ideal for Printed Circuit Board Applications
- UL Listed Under Recognized Component Index, File Number E95060
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative.**

GBJ

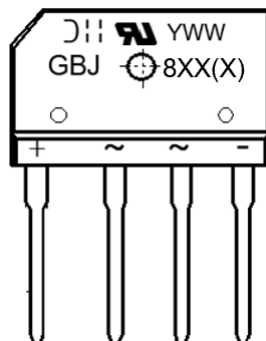


Ordering Information (Note 3)

Orderable Part Number	Package	Packing	
		Qty.	Carrier
GBJ8005-F	GBJ	15	Tube
GBJ801-F	GBJ	15	Tube
GBJ802-F	GBJ	15	Tube
GBJ804-F	GBJ	15	Tube
GBJ806-F	GBJ	15	Tube
GBJ808-F	GBJ	15	Tube
GBJ810-F	GBJ	15	Tube

- Notes:
- EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 - See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



GBJ8XX = Product Type Marking Code, ex: GBJ801, GBJ802, GBJ804, GBJ806, GBJ808, GBJ810
 GBJ8XXX = Product Type Marking Code, ex: GBJ8005
 J = Manufacturer's Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 6 = 2026)
 WW = Week Code (01 to 53)

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	GBJ8005	GBJ801	GBJ802	GBJ804	GBJ806	GBJ808	GBJ810	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Average Forward Rectified Output Current @ $T_C = +110^\circ\text{C}$	I_O	8.0							A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half-Sine Wave Superimposed on Rated Load	I_{FSM}	170							A
I^2t Rating for Fusing ($t = 8.3\text{ms}$)	I^2t	120							A^2s
Operating Temperature Range	T_J	-55 to +150							$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150							$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Test Conditions		Symbol	Min	Typ	Max	Unit
Breakdown Voltage	$I_R = 5\mu\text{A}$, $T_A = +25^\circ\text{C}$		V_B	50/100/200/400 /600/800/1000	—	—	V
Forward Voltage	$I_F = 4.0\text{A}$, $T_A = +25^\circ\text{C}$		V_F	—	—	1.0	V
Leakage Current	V_R at Rated	$T_C = +25^\circ\text{C}$ $T_C = +125^\circ\text{C}$	I_R	— —	— —	5 500	μA
Typical Total Capacitance per Element (Note 4)			C_T	55			pF

Thermal Characteristics

Characteristic	Symbol	Typ	Unit
Typical Thermal Resistance (Note 5)	$R_{\theta JC}$	1.6	$^\circ\text{C/W}$

Notes: 4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
5. Thermal resistance from junction to case per element. Unit mounted on 100mm x 100mm x 1.6mm aluminum plate heatsink.

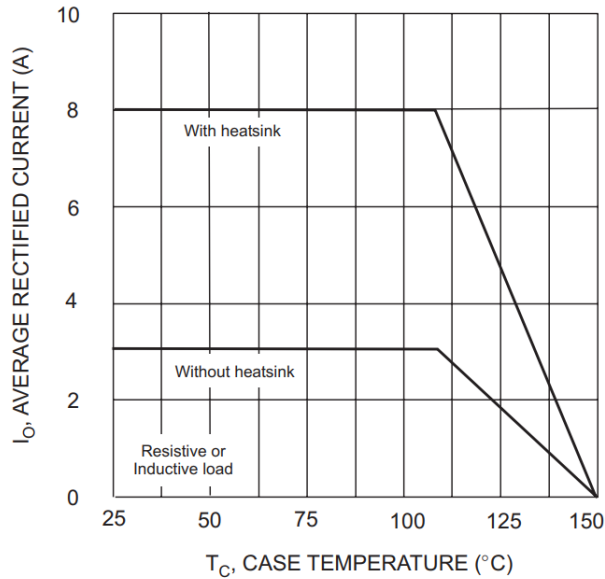


Fig. 1 Forward Current Derating Curve

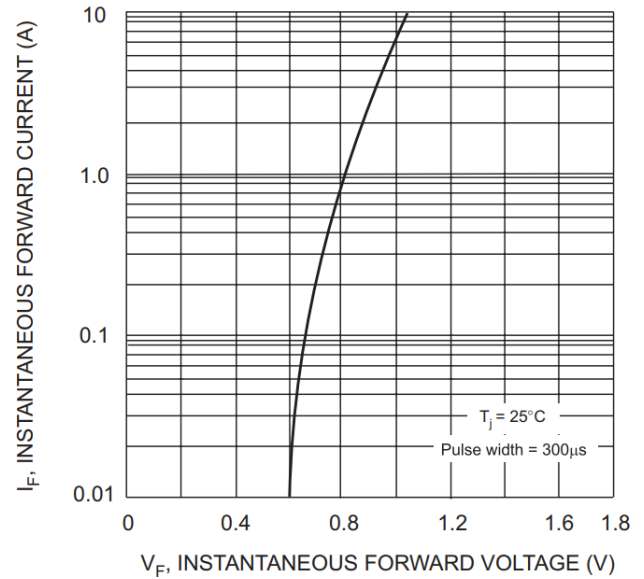


Fig. 2 Typical Forward Characteristics (per element)

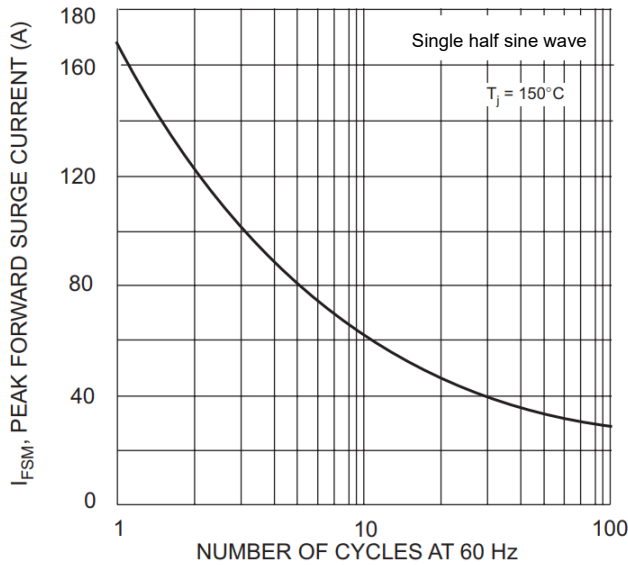


Fig. 3 Maximum Non-Repetitive Surge Current

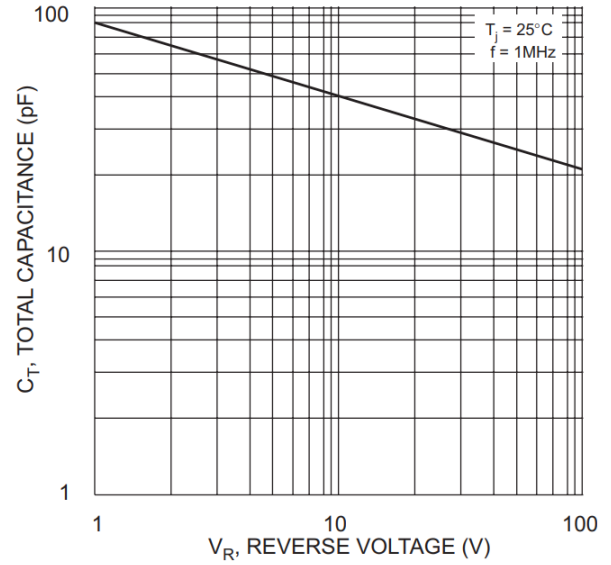


Fig. 4 Typical Total Capacitance (per element)

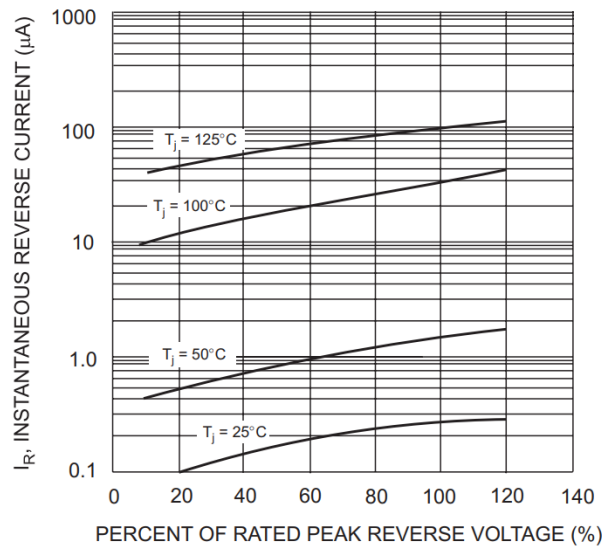
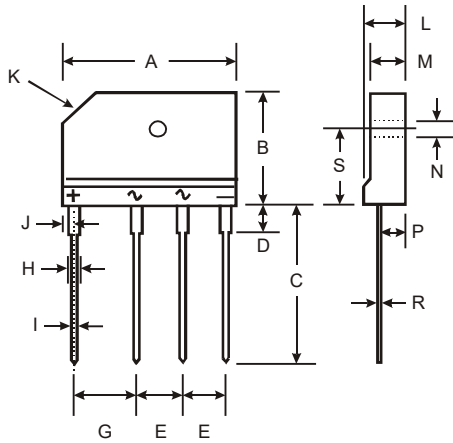


Fig. 5 Typical Reverse Characteristics

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

GBJ



GBJ		
Dim	Min	Max
A	29.70	30.30
B	19.70	20.30
C	17.00	18.00
D	3.80	4.20
E	7.30	7.70
G	9.80	10.20
H	2.00	2.40
I	0.90	1.10
J	2.30	2.70
K	3.0 X 45°	
L	4.40	4.80
M	3.40	3.80
N	3.10	3.40
P	2.50	2.90
R	0.60	0.80
S	10.80	11.20
All Dimensions in mm		

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